











# **42 SERIES**

#### **5A HIGH CURRENT ▲ SI MOSFET RELAY**

SILICON Si MOSFET RELAY ▲ DIP and SMD type Up to 5000mA ▲ Switches AC or DC load One channel and two channel packages available Input TTL / CMOS compatible Moisture Sensitivity Level ▲ MSL 1

UL 1577 approved ▲ File no E344988

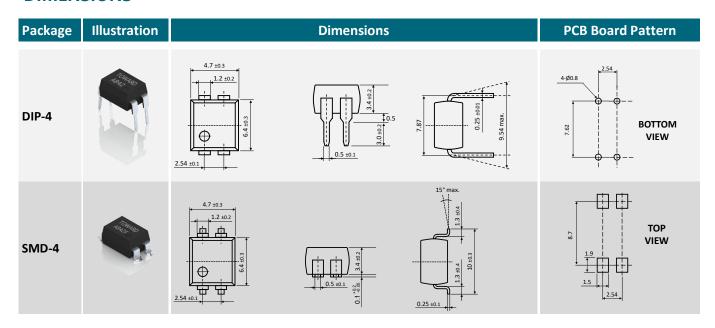
### **SPECIFICATION**

Item		Characteristics
Contact Form		1 Form A / 2 Form A ▲ Normally open switch
Load Voltage	$V_L$	60V
Operation LED Current	I <sub>F ON</sub>	3mA
Load Current	I <sub>L</sub>	5000mA
On-Resistance	Ron	0.02Ω
Output Capacitance	Соит	1300pF
Low Off-State Leakage Current	I <sub>LEAK</sub>	1μA at 60V <sub>DC</sub>

### **APPLICATIONS**

Automatic Test	I/O	Industrial	Measurement	Security	Sensing	Telecom
Equipment	Modules	Automation	Equipment	Equipment	Equipment	Equipment
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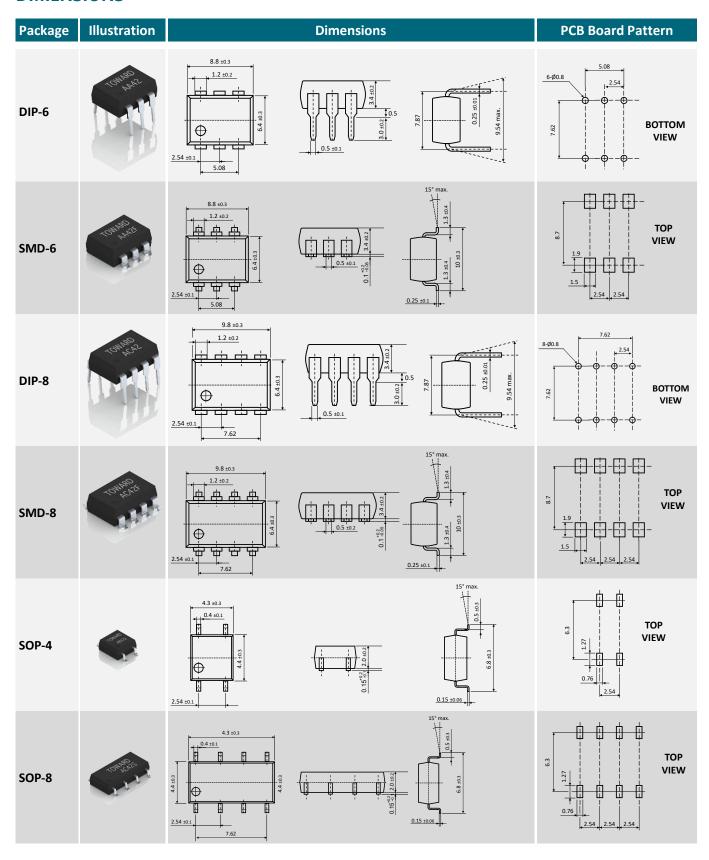
#### **DIMENSIONS**



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### **DIMENSIONS**





# ABSOLUTE MAXIMUM RATINGS $\blacktriangle$ AMBIENT TEMPERATURE $T_A = 25^{\circ}C$

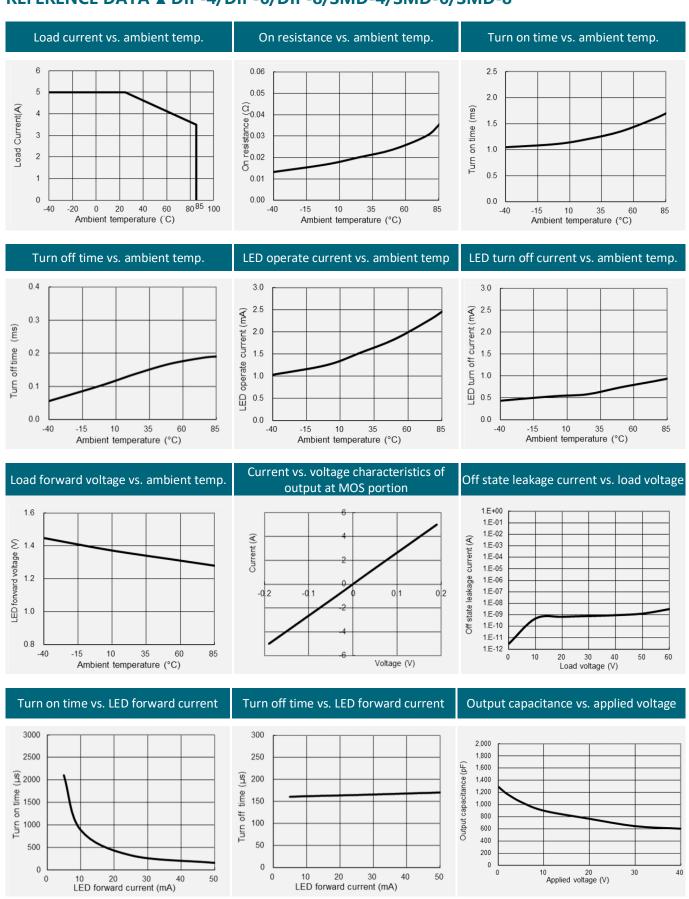
	Item	Condition	Symbol			Value		_	Unit
	Outline package			SOP-4	SOP-8	DIP-4 SMD-4	DIP-8 SMD-8	DIP-6 SMD-6	
Туре	Part number			AB42S	AC42S	AB42(F)	AC42(F)	AA42(F)	
	Output channels			1	2	1	2	1	Channels
	Continuous LED Current		I <sub>F</sub>			50			mA
Lancet	Peak LED Current	100 Hz, Duty 1%	I <sub>FP</sub>			500			mA
Input	LED Reverse Voltage		$V_R$	5			V		
	Input Power Dissipation		P <sub>IN</sub>	75			mV		
	Load Voltage		$V_{L}$		60 (	AC peak o	r DC)		V
Outrot	Load Current		IL	2500	2000	2500	2000	5000	mA
Output	Peak Load Current	1 ms, 1 shot	I <sub>PEAK</sub>	6000	6000	6000	6000	14000	mA
	Output Power Dissipation		P <sub>OUT</sub>	400	450	400	450	800	mW
	Total Power Dissipation		$P_{T}$	450	500	450	500	850	mW
	I/O Breakdown Voltage		V <sub>I/O</sub>	1500	1500	3750	3750	3750	$V_{RMS}$
Relay	I/O Breakdown Voltage (Suffix-H)		$V_{\text{I/O}}$	3750	3750	5000	5000	5000	$V_{\text{RMS}}$
	Operating Temperature Range		$T_{OPR}$	-40 to +85			°C		
	Storage Temperature Range		$T_{STG}$		-	40 to +10	0		°C

# **ELECTRICAL CHARACTERISTICS** ▲ **AMBIENT TEMPERATURE** T<sub>A</sub> = 25°C

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I <sub>F</sub> = 10mA	$V_{F}$	1	1.37	1.5	V
Input	Operation LED Current		I <sub>F ON</sub>		1 1.7 (DIP6)	5	mA
	Recovery LED Voltage		$V_{FOFF}$	0.5	1.2		V
	On-Resistance				0.053	0.064	
	Drain to Drain (tested within 1 sec.)	I <sub>F</sub> =5mA, I <sub>L</sub> =Rating	R <sub>ON</sub>		0.02 (DIP6)	0.032 (DIP6)	Ω
Output	Off-State Leakage Current	V <sub>L</sub> = 60V	I <sub>LEAK</sub>			1	μΑ
	Output Capacitance	V <sub>L</sub> =0V, f=1MHz	C <sub>OUT</sub>		400 1300 (DIP6)		pF
	Turn-On Time (for SOP/DIP4,8 type)	I <sub>F</sub> =5mA, I <sub>L</sub> =Rating	t <sub>on</sub>		0.8	3	ms
Trans-	Turn-Off Time (for SOP/DIP4,8 type)	I <sub>F</sub> =5mA, I <sub>L</sub> =Rating	t <sub>OFF</sub>		0.15	0.5	ms
mission	Turn-On Time (for DIP6 type)	I <sub>F</sub> =10mA, I <sub>L</sub> =Rating	t <sub>on</sub>		1.2	3	ms
	Turn-Off Time (for DIP6 type)	I <sub>F</sub> =10mA, I <sub>L</sub> =Rating	t <sub>OFF</sub>		0.15	0.5	ms
Coupled	I/O Insulation Resistance		R <sub>I/O</sub>	<b>10</b> <sup>9</sup>			Ω
Coupled	I/O Capacitance	f=1MHz	C <sub>I/O</sub>		1.3		pF



# REFERENCE DATA A DIP-4/DIP-6/DIP-8/SMD-4/SMD-6/SMD-8



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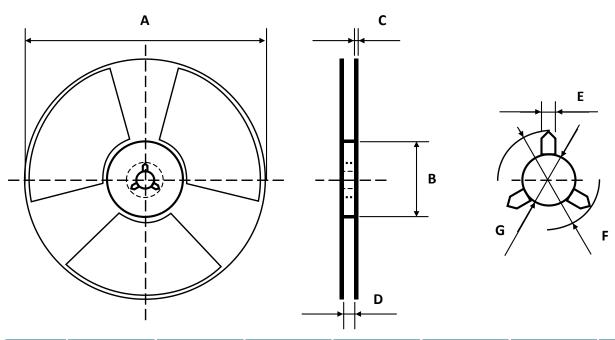


# PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pin	Description	Part No.	Package	Packing
1 2	1 2 3,4	Anode (+) • LED Cathode (-) • LED Drain • MOSFET	AB42 AB42F AB42S AB42F-R1 AB45S-R1	DIP-4 SMD-4 SOP-4 SMD-4 SOP-4	Tube (90pcs) Tube (90pcs) Tube (100pcs) Reel (1000pcs) Reel (1000pcs)
1 2 3	1 2 3 4,6 5	Anode (+) • LED Cathode (-) • LED NC Drain • MOSFET Source • MOSFET	AA42 AA42F AA42F-R1	DIP-6 SMD-6 SMD-6	Tube (50pcs) Tube (50pcs) Reel (1000pcs)
1 2 3 4	1,3 2,4 5,6,7,8	Anode (+) • LED Cathode (-) • LED Drain • MOSFET	AC42 AC42F AC42S AC42F-R1 AC42S-R1	DIP-8 SMD-8 SOP-8 SMD-8 SOP-8	Tube (45pcs) Tube (45pcs) Tube (50pcs) Reel (1000pcs) Reel (1000pcs)

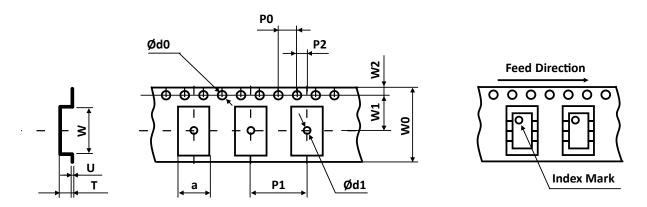


# **REEL DIMENSIONS** ▲ All dimensions in mm



Size	А	В	С	D	Е	F	G
SOP-4	330	100	2	13	2	13	21
SOP-8	330	100	2	17	2	13	21
SMD-4	380	80	2.2	17	2	13	21
SMD-6	380	80	2.2	17	2	13	21
SMD-8	380	80	2.2	17	2	13	21

# **TAPE DIMENSIONS** ▲ All dimensions in mm



Size	w	U	т	а	Ød0	Ød1	P0	P1	P2	W0	W1	W2
SOP-4	4.6	0.3	2.3	7.2	1.5	1.5	4	12	2	12	7.5	1.75
SOP-8	10.4	0.3	2.3	7.5	1.5	1.5	4	12	2	16	7.5	1.75
SMD-4	5.3	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75
SMD-6	9.15	0.3	4.45	10.4	1.5	1.5	4	16	2	16	11.5	1.75
SMD-8	9.9	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75

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# **PACKING QUANTITIES**

Tape and Reel Packing	PCS/Reel
SMD-4	1000
SMD-6	1000
SMD-8	1000
SOP-4	1000
SOP-8	1000

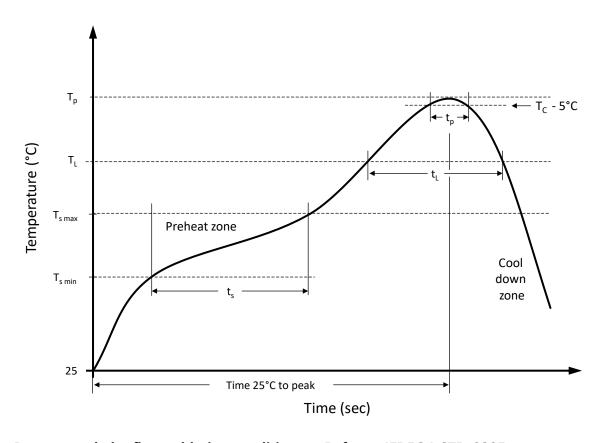
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
DIP-4	90	30	2700
DIP-6	50	30	1500
DIP-8	45	30	1350
SMD-4	90	30	2700
SMD-6	50	30	1500
SMD-8	45	30	1350
SOP-4	100	30	3 000
SOP-8	50	30	1500

# STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T <sub>A</sub> < 30°C, RH < 85%	1



### RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE

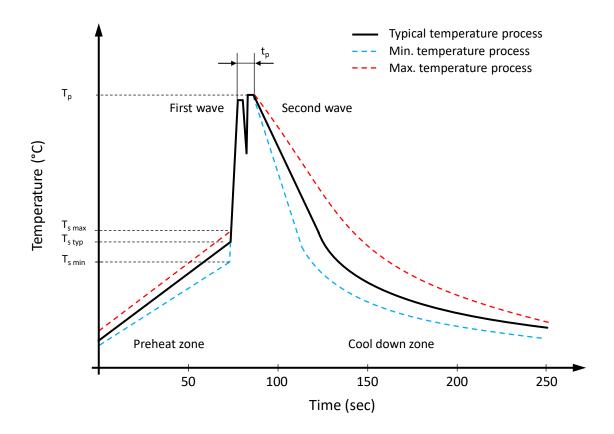


# **Recommended reflow soldering conditions** ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	T <sub>s min</sub>	100 °C	150 °C
Preheat temperature max.	T <sub>s max</sub>	150 °C	200 °C
Preheat time t <sub>s</sub> from T <sub>s min</sub> to T <sub>s max</sub>	$t_s$	120 seconds	120 seconds
Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	$T_L$	183 °C	217 °C
Time t₁ maintained above T₁	t <sub>L</sub>	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	t <sub>p</sub>	20 seconds max.	30 seconds max.
Ramp-down rate (T <sub>L</sub> to T <sub>p</sub> )		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes



### RECOMMENDED WAVE SOLDERING PROFILE A THT PACKAGE



# Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value ▲ Sn-Pb Assembly	Value ▲ Pb-free Assembly
Preheat temperature min.	$T_{smin}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{smin}$ to $T_{smax}$	ts	70 seconds	70 seconds
Peak temperature	$T_p$	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



# LOAD CONNECTING METHOD

Туре		Load	Connection	Feature
4 pins		AC or DC	V <sub>L</sub> (AC or DC)	Control bi-directional signal
	Α	AC or DC	V <sub>L</sub> (AC or DC)	Control bi-directional signal
6 pins	6 pins B	DC	V <sub>L</sub> (DC)	On-resistance is 1/2 of A-connection
			l <sub>E</sub> V <sub>L</sub> (DC)	2-Make-contacts (Source Common)
	С	DC	V <sub>L</sub> (DC)	On-Resistance is 1/2 of B-connection
	AC or DC		Load  V <sub>L</sub> (AC or DC)  V <sub>L</sub> (AC or DC)	2 input and 2 output
8 pins			Load  V <sub>L</sub> (AC or DC)  V <sub>L</sub> (AC or DC)	1 input and 2 output



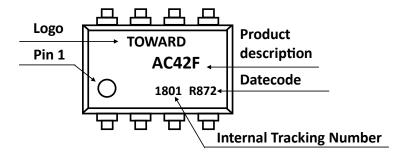
# **PRODUCT CODE**

Example: AC42F series ▲ 2 Form A ▲ 60V ▲ SMD-8 ▲ Tape & Reel

AC		42		-		F		R1	
Package		Sei	Series Spe		ecial Suffix	Туре		Packing	
AA AB AC	6 Pin ▲ 1 Form A 4 Pin ▲ 1 Form A 8 Pin ▲ 2 Form A	42	60V	Blank H	Standard High Insulation	Blank F S	DIP SMD SOP	Blank R1	Tube Reel

### **PRODUCT MARKING**

Example: AC42F series ▲ 2 Form A ▲ 60V ▲ SMD-8 ▲ Tape & Reel



### **DATE CODE**

Example: R872

R		8		7		2	
Material Characteristics		Year		Month		Week of the Month	
R H	RoHS compliant Halogen free	8 9 A B C  G	2018 2019 2020 2021 2022  2026	1 2 3 4 5 	Jan Feb Mar Apr May  Dec	1 2 3 4	1 <sup>st</sup> 2 <sup>nd</sup> 3 <sup>rd</sup> 4 <sup>th</sup>



# RELIABILITY TESTS **A** STANDARD

Standard: JESD22-A

No.	Test	Test Specification	Test Standard	Test Limits
1	Moisture Sensitivity Level Test	Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	JESD22-A113H	No abnormal phenome- non was found. Functional test passed.
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenomenon was found. Functional test passed.
3	Temperature Cycling Test	·		No abnormal phenomenon was found. Functional test passed.
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenomenon was found. Functional test passed.
5	Temperature & Temperature: 85°C Humidity Storage Humidity: 85% RH Test Duration: 500 hours		JESD22-A101D	No abnormal phenomenon was found. Functional test passed.
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenomenon was found. Functional test passed.



#### **REVISION TABLE**

Revision	Date	Status	Notes
001	01/04/2022	Initial release	Initial publication

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